1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Paramete	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage			100	V	
I _{F(RMS)}	Forward rms current			10	А	
1	Average forward current, δ = 0.5, square	$T_{c} = 135 \ ^{\circ}C^{(1)}$	Per diode	7.5	А	
IF(AV)	wave		Per device	15	~	
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			75	А	
P _{ARM}	Repetitive peak avalanche power	475	W			
T _{stg}	Storage temperature range			-65 to +175	°C	
Т _ј	Maximum operating junction temperature ⁽²⁾			175	°C	

1. Value based on $R_{th(j-c)}$ max (per diode)

2. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 2	Thormol	registeres
Table 3.	inermai	resistance

Symbol	Parameter	Value	Unit	
D	Junction to case	Per diode	4	
R _{th(j-c)}		Total	2.4	°C/W
R _{th(c)}	Coupling		0.7	

When the diodes 1 and 2 are used simultaneously:

 ΔT_j (diode 1) = P(diode1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	$V_{R} = V_{RRM}$			3	μA
		T _j = 125 °C			1.3	4	mA
VF ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 7.5 A			0.8	V
		T _j = 125 °C	I _F = 7.5 A		0.62	0.67	
		T _j = 25 °C	I _F = 12 A			0.85	
		T _j = 125 °C	I _F = 12 A		0.68	0.73	
		T _j = 25 °C	I _F = 15 A			0.89	
		T _j = 125 °C	I _F = 15 A		0.71	0.76	

Table 4. Static electrical characteristics (per diode)

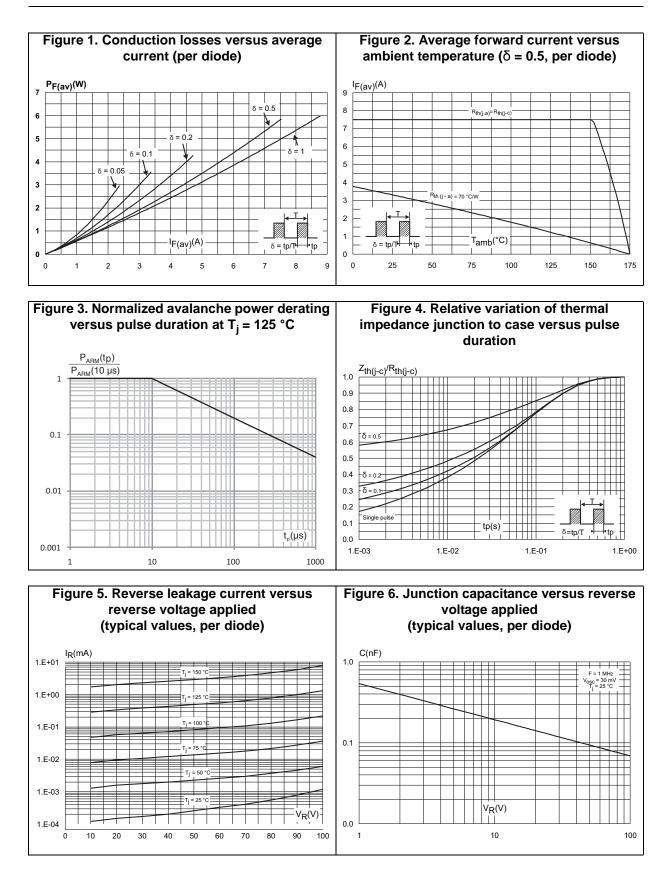
1. $t_p = 5 \text{ ms}, \delta < 2\%$

2. t_p = 380 μs, δ < 2%

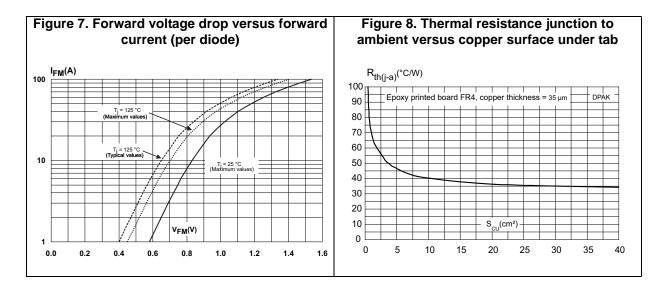
To evaluate the conduction losses use the following equation:

 $P = 0.58 \text{ x } I_{F(AV)} + 0.012 I_{F}^{2}(RMS)$











2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

2.1 DPAK package information

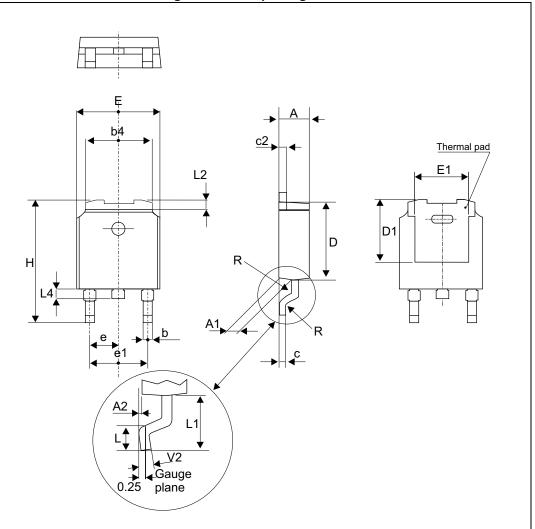


Figure 9. DPAK package outline

Note:

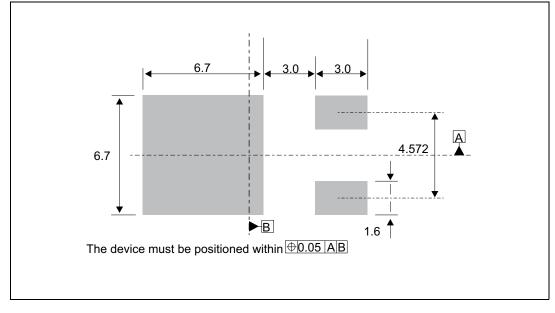
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	2.18		2.40	0.085		0.094	
A1	0.90		1.10	0.035		0.043	
A2	0.03		0.23	0.001		0.009	
b	0.64		0.90	0.025		0.035	
b4	4.95		5.46	0.194		0.214	
С	0.46		0.61	0.018		0.024	
c2	0.46		0.60	0.018		0.023	
D	5.97		6.22	0.235		0.244	
D1	4.95		5.60	0.194		0.220	
E	6.35		6.73	0.250		0.264	
E1	4.32		5.50	0.170		0.216	
е		2.28			0.090		
e1	4.40		4.70	0.173		0.185	
Н	9.35		10.40	0.368		0.409	
L	1.00		1.78	0.039		0.070	
L2			1.27			0.050	
L4	0.60		1.02	0.023		0.040	
V2	-8°		+8°	-8°		8°	

Table 5. DPAK package mechanical data

Figure 10. DPAK footprint dimensions (in mm)





3 Ordering Information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS15H100CB	S15H100	DPAK	0.30 g	75	Tube
STPS15H100CB-TR	S15H100	DPAK	0.30 g	2500	Tape and reel

4 Revision history

Date Revision		Description of Changes
Mar-2004	3	Last issue
08-Jun-2006	4	Reformatted to current standard. Added IPAK.
01-Aug-2014	5	Updated DPAK package information and reformatted to current standard. Removed IPAK.
17-Sep-2014	6	Updated Figure 3 and Figure 11.
18-Dec-2015	7	Updated DPAK package information and reformatted to current standard.

Table 7. Document revision history



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